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United States Patent [19]

Huber et al.

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[54] **CARRIER ELEMENT FOR A SEMICONDUCTOR CHIP FOR INTEGRATION INTO A CHIPCARD, OR A CHIPCARD MODULE**

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[73] Assignee: **Siemens Aktiengesellschaft**, Munich, Germany

[**] Term: **14 Years**

[21] Appl. No.: **76,605**

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[30] **Foreign Application Priority Data**

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[51] **LOC (6) Cl. 13-03**

[52] **U.S. Cl. D13/182**

[58] **Field of Search D13/182; 361/748, 361/752, 809; 174/250, 253, 255**

[56] **References Cited**

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[57] **CLAIM**

The ornamental design for a carrier element for a semiconductor chip for integration into a chipcard, or a chipcard module, as shown and described.

DESCRIPTION

The single FIGURE is a top perspective view of a carrier element for a semiconductor chip for integration into a chipcard, or a chipcard module showing our new design. The features on the undisclosed bottom are not claimed.

1 Claim, 1 Drawing Sheet



